



Diode Modules MDx800



$I_{F(AV)}$ **800A**
 V_{RRM} **600~1800V**
 I_{FSM} **$22A \times 10^3$**
 I^2t **$2420A^2 \cdot S \cdot 10^3$**

Features:

- Isolated mounting base 2500V~
- Pressure contact technology with
Increased power cycling capability
- Space and weight savings

Typical Applications

- AC/DC Motor drives
- Various rectifiers
- DC supply for PWM inverter

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT
				Min	Type	Max	
$I_{F(AV)}$	Mean forward current	180° half sine wave 50Hz Single side cooled, T _C =100°C	150			800	A
$I_{F(RMS)}$	RMS forward current		150			1256	A
V_{RRM}	Repetitive peak reverse voltage	$V_{RRM} tp=10ms$ $V_{RSM}=V_{RRM}+100V$	150	600		1800	V
I_{RRM}	Repetitive peak current	at V_{RRM}	150			45	mA
I_{FSM}	Surge forward current	10ms half sine wave	150			22.0	KA
I^2t	I^2T for fusing coordination	$V_R=0.6V_{RRM}$					2420
V_{FO}	Threshold voltage		150			0.72	V
r_F	Forward slop resistance						0.18
V_{FM}	Peak forward voltage	$I_{FM}=2400A$	25			1.80	V
$R_{th(j-c)}$	Thermal resistance Junction to case	At 180° sine: Single side cooled				0.058	°C /W
$R_{th(c-h)}$	Thermal resistance case to heat sink	At 180° sine: Single side cooled				0.020	°C /W
V_{iso}	Isolation voltage	50Hz, R.M.S, t=1min, $I_{iso}: 1mA(max)$		2500			V
F_m	Terminal connection torque(M12)				14		N·m
	Mounting torque(M8)				12		N·m
T_{stg}	Stored temperature			-40		125	°C
W_t	Weight				3500		g
Outline							

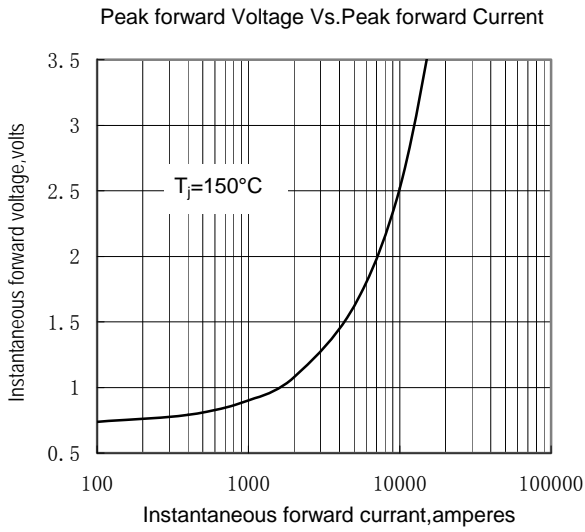


Fig.1

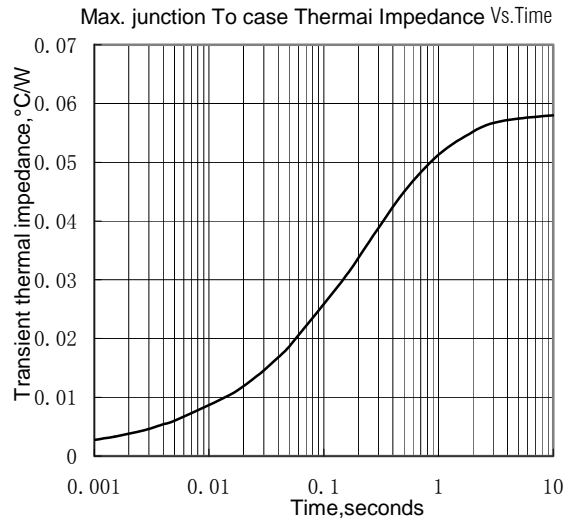


Fig.2

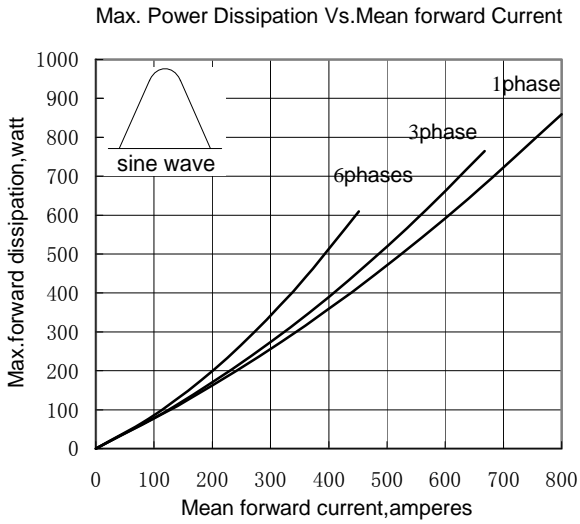


Fig.3

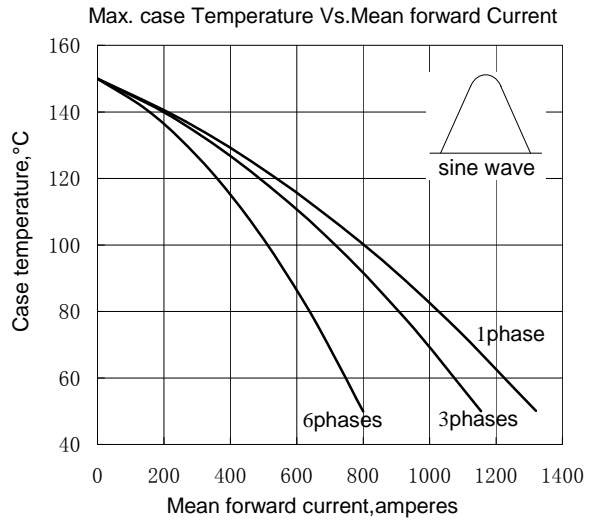


Fig.4

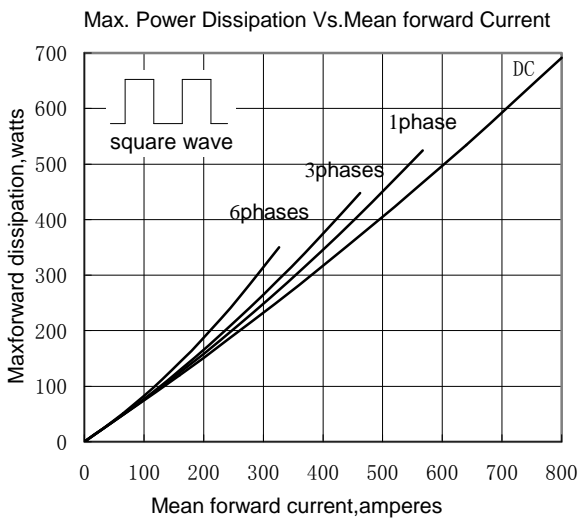


Fig.5

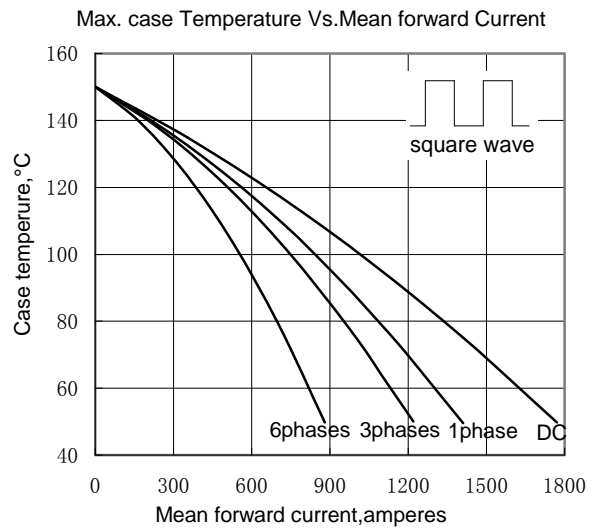


Fig.6

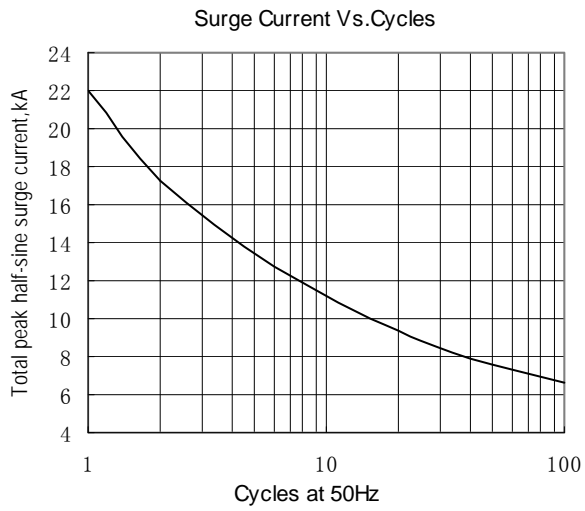


Fig.7

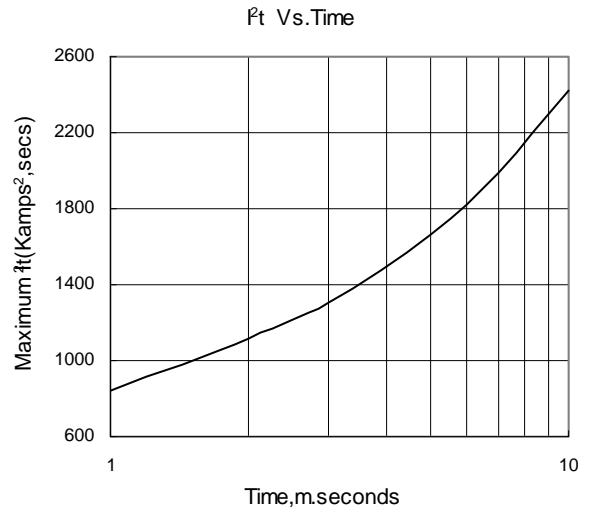


Fig.8

Outline:

